

Thermogravimetric Analysis and Calorimetry (Mexico)

## Unidad de Análisis Termogravimétrico

**Absorbance** – a measure of the amount of light absorbed by a sample at a specific wavelength; related terms: transmittance, Beer-Lambert law; example: in coupled TGA-FTIR, absorbance peaks identify gas species; challenge: baseline drift can affect quantitative analysis.

**Baseline** – the reference line representing instrument response with no sample; related terms: drift, correction, zeroing; example: a stable baseline is essential for accurate mass loss integration; challenge: thermal expansion of the sample holder may cause baseline shifts.

**Calibration** – procedure to establish the relationship between instrument signal and known standards; related terms: standard reference material, sensitivity, factor; example: calibrating a TGA using an alumina standard ensures accurate temperature readings; challenge: frequent recalibration is required for high-precision work.

**Derivative Thermogravimetry (DTG)** – the first derivative of the TGA curve, showing rate of mass change; related terms: TG curve, peak deconvolution, kinetic analysis; example: DTG peaks reveal overlapping decomposition steps of a polymer; challenge: noise amplification may obscure minor events.

**Decomposition Temperature** – the temperature at which a material begins to break down chemically; related terms: onset temperature, peak temperature, thermal stability; example: polypropylene shows a decomposition temperature around 350 °C; challenge: heating rate influences the observed onset.

**Evolved Gas Analysis (EGA)** – technique that identifies gases released during thermal events; related terms: TGA-MS, TGA-FTIR, coupling; example: EGA detects CO<sub>2</sub> release from calcium carbonate decomposition; challenge: overlapping mass spectra require careful interpretation.

**Heating Rate** – the speed at which temperature is increased during an experiment, expressed in °C min<sup>-1</sup>; related terms: isothermal, ramp, kinetic parameters; example: a 10 °C min<sup>-1</sup> rate is common for polymer degradation studies; challenge: high rates can shift kinetic parameters.

**Inert Atmosphere** – a non-reactive gas environment, typically nitrogen or argon, used to prevent oxidation; related terms: purge, protective gas, oxidative atmosphere; example: nitrogen flow protects a cellulose sample from combustion; challenge: leaks can introduce oxygen, altering results.

**Isothermal TGA** – thermogravimetric measurement performed at a constant temperature; related terms: isothermal hold, stepwise heating, kinetic modeling; example: isothermal TGA at 200 °C assesses moisture desorption; challenge: temperature stability is critical for accurate kinetic data.

**Kinetic Model** – mathematical description of reaction rates, such as first-order or Avrami; related terms: activation energy, pre-exponential factor, model fitting; example: a first-order kinetic model describes the degradation of a low-density polyethylene; challenge: selecting the correct model requires statistical

validation.

Mass Loss – the reduction in sample weight recorded as a function of temperature or time; related terms: percent loss, residual mass, yield; example: a 5 % mass loss at 150 °C indicates moisture evaporation; challenge: instrument drift can mask small losses.

Mass Spectrometer (MS) – detector that measures mass-to-charge ratios of ionized gases; related terms: EGA, ion source, quadrupole; example: TGA-MS identifies H<sub>2</sub>O, CO, and CO<sub>2</sub> during polymer pyrolysis; challenge: fragmentation patterns may complicate identification.

Moisture Content – amount of water present in a sample, often expressed as percent of total mass; related terms: desorption, hygroscopicity, drying; example: moisture content of a soil sample is determined by the mass loss up to 105 °C; challenge: bound water may require higher temperatures for complete removal.

Nitrogen Flow – the rate at which nitrogen gas is supplied to the sample chamber; related terms: purge rate, carrier gas, flow controller; example: a 50 mL min<sup>-1</sup> nitrogen flow maintains an inert environment; challenge: excessive flow can cause sample spattering.

Oxidative Atmosphere – presence of oxygen, usually supplied as air or synthetic air, to study combustion or oxidation; related terms: air, O<sub>2</sub>, combustion analysis; example: oxidative TGA reveals the ash residue after burning a biomass sample; challenge: controlling oxygen partial pressure is essential for reproducible results.

Peak Deconvolution – mathematical separation of overlapping DTG peaks into individual components; related terms: Gaussian fitting, resolution, kinetic extraction; example: deconvolution isolates cellulose and hemicellulose degradation peaks in wood; challenge: over-fitting can produce non-physical results.

Primary Standard – a material with certified properties used for instrument calibration; related terms: reference material, traceability, certification; example: NIST-SRM 1633b serves as a primary standard for TGA temperature calibration; challenge: limited availability may restrict routine use.

Quantitative Analysis – determination of the amount or concentration of a component based on measured response; related terms: calibration curve, limit of detection, accuracy; example: quantitative EGA determines the fraction of CO<sub>2</sub> evolved from carbonate decomposition; challenge: matrix effects can bias results.

Residual Mass – the final mass remaining after a thermal program, often indicating char or ash; related terms: char yield, ash content, final weight; example: a residual mass of 12 % after heating to 800 °C suggests inorganic filler in a polymer; challenge: incomplete combustion may lead to overestimation.

Sample Preparation – procedures to condition a sample before analysis, including grinding, drying, and weighing; related terms: homogenization, sieving, mass loading; example: grinding a catalyst to 30 kV mm<sup>-1</sup>; challenge: meeting all specifications can necessitate trade-offs.

Thermal Conductivity Specification Sheet – document outlining the technical parameters of a conductive material; related terms: product data, technical brief, compliance; example: the sheet lists conductivity,

density, thermal expansion, and operating temperature range; challenge: keeping the sheet updated with latest test results ensures accuracy.

Thermal Conductivity Certification – formal acknowledgment that a material meets defined standards; related terms: compliance, audit, accreditation; example: certification confirms that a composite satisfies ISO 9001 quality management requirements; challenge: maintaining certification demands ongoing quality control.

Thermal Conductivity Quality – degree to which a material consistently meets its intended conductivity; related terms: control, assurance, standards; example: quality control includes regular measurement of conductivity on production batches; challenge: process variability can lead to out-of-spec products.

Thermal Conductivity Process – series of steps used to produce a conductive material; related terms: synthesis, extrusion, curing; example: the process may involve melt mixing of polymer and conductive filler, followed by hot-pressing; challenge: scaling the process while preserving conductivity uniformity is often difficult.

Thermal Conductivity Manufacturing – industrial production of materials with tailored heat transfer properties; related terms: plant, line, scale-up; example: manufacturing lines produce conductive polymer sheets for automotive heat exchangers; challenge: ensuring consistent filler dispersion across large volumes requires robust equipment.

Thermal Conductivity Supply Chain – network of suppliers and distributors involved in delivering conductive materials; related terms: logistics, sourcing, inventory; example: supply chain management ensures timely availability of high-purity graphene for composite production; challenge: geopolitical factors can disrupt supply of critical raw materials.

Thermal Conductivity Market – economic sector dealing with heat-transfer materials and technologies; related terms: demand, forecast, competition; example: the market for thermal interface materials is projected to grow at 8% CAGR; challenge: price competition drives continuous innovation.

Thermal Conductivity Cost – financial expense associated with acquiring or producing conductive material; related terms: price, budget, cost-benefit; example: the cost of high-performance fillers can dominate the overall material expense; challenge: achieving cost-effective solutions without sacrificing performance remains a priority.

Thermal Conductivity Investment – allocation of resources to develop or acquire conductive technologies; related terms: capital, ROI, funding; example: investment in R&D aims to create next-generation high-conductivity polymers; challenge: long development cycles can affect return on investment.

Thermal Conductivity Return on Investment – metric evaluating the financial benefits of conductivity improvements; related terms: profit, savings, efficiency; example: improved thermal management reduces cooling system costs, yielding a favorable ROI; challenge: quantifying intangible benefits, such as reliability gains, can be difficult.

**Thermal Conductivity Savings** – cost reductions achieved through more efficient heat transfer; related terms: energy reduction, operational expense, optimization; example: using high-conductivity materials in heat exchangers lowers the required pump power; challenge: initial material costs may offset short-term savings.

**Thermal Conductivity Benefit** – advantage gained from enhanced heat transfer, such as increased performance; related terms: advantage, gain, improvement; example: the benefit of higher conductivity includes faster device cooling and extended lifespan; challenge: communicating benefits to stakeholders requires clear data.

**Thermal Conductivity Advantage** – competitive edge obtained by superior conductive properties; related terms: differentiation, market position, superiority; example: an advantage in thermal management can differentiate a smartphone from competitors; challenge: sustaining the advantage necessitates continual innovation.

**Thermal Conductivity Challenge** – (see earlier entry for challenges in measurement and enhancement).

**Thermal Conductivity Solution** – approach or technology that addresses a specific heat transfer problem; related terms: remedy, strategy, implementation; example: a solution may involve embedding metal nanowires to create conductive pathways; challenge: integrating the solution without affecting other material properties.

**Thermal Conductivity Strategy** – plan to achieve desired heat transfer performance; related terms: roadmap, objectives, tactics; example: a strategy may combine material selection, processing optimization, and testing; challenge: aligning strategy with business goals is essential.

**Thermal Conductivity Roadmap** – timeline outlining milestones for developing conductive technologies;